

07-28-00

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
UTILITY PATENT APPLICATION TRANSMITTAL LETTER

Attorney Docket No.: FD20014Mailing Date: July 27 2000Express Mail Label No.: EK189345025US

To: Assistant Commissioner for Patents
Box Patent Application
Washington D.C., 20231

Dear Sir:

Transmitted herewith for filing under 37 C.F.R. 1.53(b) is a Nonprovisional Utility Patent Application:

- ☒ New Application; or
- ☐ Continuation; or ☐ Divisional; or ☐ Continuation-In-Part (CIP);
of prior US Application No. _____, filed on _____, having U.S.
Examiner _____, in Group Art Unit _____

Of: Matthew Stainer, Shawn M. O'Rourke, Kazuo Kato, and Susumu Sakamoto

For: **FIELD EMISSION DISPLAY AND METHOD OF MANUFACTURE**

- ☒ 2 sheets of drawings and 10 pages of specification and claims.
- ☒ Newly executed oath or declaration combined with Power of Attorney on 3 pages.
- ☐ Copy of oath or declaration from prior U.S. application serial no. _____
☐ The following named inventor(s) from the prior application are hereby deleted from this application in accordance with 37 C.F.R. 1.63(d)(2) and 1.33(b):

- ☐ Foreign priority to _____ patent application having serial number _____ and a filing date of _____, is hereby claimed under 35 USC 119.
☐ A copy of the priority document is included herewith.
- ☒ An Assignment Transmittal Letter and Assignment of the invention to Motorola, Inc.
- ☒ An Information Disclosure Statement (IDS), with PTO-1449, and 8 citation copies.
- ☒ Return Receipt Postcard.
- ☐ Preliminary Amendment.
- ☐ Please cancel pending claims _____.
- ☐ Incorporation by Reference (for Continuation/Division/CIP application). The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein. Since the present application is based on a prior US application, please

JC857 U.S. PTO
09/626979

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JC846 U.S. PTO
07/27/00

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amend the specification by adding the following sentence before the first sentence of the specification:

"The present application is based on prior US application No. _____, filed on _____, which is hereby incorporated by reference, and priority thereto for common subject matter is hereby claimed."

- ☐ Applicant hereby petitions pursuant to 37 C.F.R. §1.136(a) for a _____ month extension of time for response to the outstanding Official Action mailed _____. The period for response was previously set to elapse _____, and is accordingly hereby extended to _____, which is still within the six-month statutory period for response (35 U.S.C. § 133) which elapses _____. The reason for this petition is that a Division, Continuation, or CIP is being filed, and it is desired to maintain the present application in pending condition pursuant to 35 USC § 120 through at least the filing of the Division, Continuation, or CIP application. The required Extension Fee established by 37 C.F.R. § 1.17(a) pursuant to 35 U.S.C. § 41(a) (8) is:

EXTENSION	FEE
<input type="checkbox"/> First Month	\$110.00
<input type="checkbox"/> Second Month	\$380.00
<input type="checkbox"/> Third Month	\$870.00
<input type="checkbox"/> Fourth Month	\$1,360.00
<input type="checkbox"/> Fifth Month	\$1,850.00

- ☒ The filing fee is calculated as follows:

CLAIMS AS FILED, LESS ANY CANCELED BY AMENDMENT

FOR	NUMBER OF CLAIMS	NUMBER EXTRA	RATE	FEE
TOTAL CLAIMS	23 - 20 =	3	x \$18	= \$ 54.00
INDEPENDENT CLAIMS	3 - 3 =	0	x \$78	= \$ 0.00
MULTIPLE DEPENDENT CLAIMS			\$260	= \$ 0.00
BASIC FEE				= \$ 690.00
TOTAL FILING FEE				= \$ 744.00

- ☒ Please charge Deposit Account No. 13-4771 in the amount of \$ 744.00 for the Total Filing Fee, and the Extension Fee under 37 C.F.R. §1.136(a), if applicable.
- ☒ The Commissioner is hereby authorized to charge any additional fees which may be required now or in the future during the entire pendency of this application under 37 C.F.R. 1.16 or 37 C.F.R. 1.17, including any present or future time extension fees which may be required, or credit any overpayment to Deposit Account No. 13-4771.

☒ This sheet is submitted in duplicate.

This transmittal letter has 3 total pages.

7-27-00
DATE

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FIELD EMISSION DISPLAY AND METHOD OF MANUFACTURE

Field of the Invention

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The present invention relates, in general, to field emission displays and, more particularly, to an anode plate for a field emission display and methods of manufacturing the anode plate.

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Background of the Invention

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Anode plates of field emission displays are comprised of a thick film system with individual "via-like" subpixels which hold phosphor. Phosphor is typically screen printed as a phosphor paste directly into each subpixel and subsequently fired. Unfortunately, due to the feature size of a typical sub-pixel, screen printing a phosphor paste is difficult and usually results in pinholes and poor phosphor uniformity. Pinholes occur due to the small feature size of the subpixel with respect to the silk screens. Poor phosphor uniformity occurs due to the nature of screen printing over a small well structure. More particularly, the phosphor paste at the beginning of the well structure will be thin and the phosphor paste at the end of the well structure will be thick.

20

Accordingly, it would be advantageous to have a method for manufacturing a field emission display wherein the phosphor layer is free of pinholes and has a uniform thickness.

Brief Description of the Drawings

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FIG. 1 is a bottom plan view of an anode plate for a field emission display in accordance with an embodiment of the present invention;

FIG. 2 is a cross-sectional view of the field emission display taken along section line 2-2 of FIG. 1;

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FIG. 3 is a cross-sectional view of the field emission display taken along section line 3-3 of FIG. 1;

FIG. 4 is an isometric view of an anode plate at an early stage of manufacture in accordance with an embodiment of the present invention;

FIG. 5 is an isometric view of the anode plate of FIG. 4 further along in manufacture;
and

FIG. 6 is an isometric view of the anode plate of FIG. 5 further along in manufacture.

For simplicity and clarity of illustration, elements in the drawings are not necessarily
5 drawn to scale, and the same reference numerals in different figures denote the same
elements.

Detailed Description of the Drawings

10 Generally, the present invention provides a field emission display and a method for
manufacturing the field emission display such that it has an anode structure that includes
channels into which a phosphor paste is disposed. The channels containing the phosphor
material may be referred to as phosphor channels. The channels allow formation of pinhole
15 free phosphor films of uniform thickness in a cost efficient manner.

FIG. 1 is a bottom plan view of an anode plate 10 for a field emission display 30 in
accordance with an embodiment of the present invention. Anode plate 10 includes a
substrate 11, which is made of a hard, transparent material, such as glass, quartz, or the like.

A channel structure 12 is formed on substrate 11 from a plurality of photosensitive
20 layers. Channel structure 12 defines a plurality of phosphor channels 13, 14, and 15, which
contain the cathodoluminescent phosphors. The embodiment of FIG. 1 is described as a
polychromatic display; however, this is not intended as a limitation of the present invention.
That is, the present invention may be a monochromatic display. So, in accordance with this
embodiment of the present invention, the phosphor material includes a red phosphor 23, a
25 green phosphor 24, and a blue phosphor 25, which define a plurality of pixels. By way of
example, and no way intended to be limiting, the dimensions of phosphor channels 13, 14,
and 15 are about 75 micrometers wide dependent on the size of the display and about 10
micrometers deep.

FIG. 2 is a cross-sectional view of field emission display 30 taken along section line
30 2-2 of FIG. 1. Field emission display 30 includes anode plate 10 and a cathode plate 31,
which opposes anode plate 10. Cathode plate 31 is spaced apart from anode plate 10 by
spacers 32 to define an interspace region 33 therebetween. One of the opposing edges of
spacer 32 contacts one of the spacer regions of channel structure 12, and the other opposing
edge of spacer 32 contacts cathode plate 31. Cathode plate 31 includes a substrate 34, upon

which are formed a cathode electrode 35 and a plurality of electron emitters 36. Electron emitters 36 oppose phosphor channels 13, 14, and 15. It should be noted that only phosphor channel 13 is shown in FIG. 2.

Channel structure 12 has a plurality of channel walls 16, which define phosphor channels 13, 14, and 15. The phosphor material is disposed within phosphor channels 13, 14, and 15. Preferably, the depth of each of phosphor channels 13, 14, and 15 is greater than the depth of phosphor 23, 24, and 25 disposed therein, respectively. This configuration provides an exposed portion of channel walls 16. The exposed portions of channel walls 16 provide many advantages. For example, for a given phosphor thickness, a greater via depth provides greater shielding of the phosphor material from the electric field. This is due to the conductive characteristic of channel structure 12. The depth of phosphor channels 13, 14, and 15 is equal to the thickness of conductive channels 13, 14, and 15, which is about 10-12 micrometers.

FIG. 3 is a cross-sectional view of field emission display 30 taken along section line 3-3 of FIG. 1. FIG. 3 illustrates spacers 32 and photosensitive films 58 and 59 as further described hereinbelow.

Now referring to FIG. 4, an isometric view of a portion of anode plate 10 at an early stage of manufacture in accordance with an embodiment of the present invention is illustrated. Anode plate 10 includes substrate 11, which can be made from a hard transparent material such as, for example, glass, quartz, or the like. A photosensitive film 58 is disposed on the surface of substrate 11. By way of example, photosensitive film 58 is made using a conductive photo-printable material, which is available from E.I. du Pont de Nemours and Company of Wilmington Delaware, and sold under the trademark FODEL. The FODEL is a mixture including glass, silver metal, and a photosensitive polymer. The glass constituent has a bonding (e.g., melting, sintering) temperature less than about 600 degrees Celsius ($^{\circ}\text{C}$). The silver composition of the FODEL ranges up to about 95 per cent by weight. The concentration of the photo-sensitive polymer is sufficient to impart photosensitivity to the dried FODEL film, so that it may be photo-patterned.

Photosensitive film 58 further includes a contrast enhancement material, such as ruthenium oxide, nickel oxide, or the like which is admixed to the FODEL paste in an amount sufficient to form a black paste. The photosensitive film 58 is then light absorbing, so that it enhances the contrast of the display image. The black paste is then silk screened onto the dry surface of substrate 11 to form a black film. The black film has a thickness

within a range of about 1.5 to 5 micrometers. Substrate 11 is then placed in a low temperature oven, and the black film is dried by heating at about 80 °C for about 20 minutes.

The dried film is then exposed to radiation such as, for example, collimated ultra-violet (UV) light, through a mask. The regions of the film that are to be removed are not exposed to the UV light. In accordance with one embodiment of the present invention, a plurality of rectangularly shaped regions or stripes 26, 27, and 28 are exposed to the UV light. Rectangularly shaped regions 26, 27, and 28 are parallel to and spaced apart from one another. Regions 26, 27, and 28 are indicated in FIG. 4 by cross-hatches in photosensitive film 58. Although three exposed rectangularly shaped regions are shown in FIG. 4, the number of rectangularly shaped regions is not a limitation of the present invention.

Now referring to FIG. 5, another photosensitive film 59 is disposed on the photosensitive film 58. By way of example, photosensitive film 59 is made using a conductive photo-printable material such as, for example, FODEL. The silver composition of the FODEL ranges up to 95 percent by weight. The concentration of the photo-sensitive polymer is sufficient to impart photo-sensitivity to the dried FODEL film, so that it may be photo-patterned. By way of example, the thickness of photosensitive film 59 ranges from about 3 to about 8 micrometers. Substrate 11 is then placed in a low temperature oven, and the photosensitive film 59 is dried by heating at about 80 °C for about 20 minutes.

The dried film is then exposed to radiation such as, for example, collimated UV light through a mask. The regions of the film that are to be removed are not exposed to the UV light. In accordance with this embodiment of the present invention, a plurality of rectangularly shaped regions or stripes 61, 62, 63, and 64 are exposed to the UV light. Rectangularly shaped regions 61, 62, 63, and 64 are spaced apart from one another. Regions 61, 62, 63, and 64 are indicated in FIG. 2 by cross-hatches in photosensitive film 59. It should be noted that the unexposed portions of photosensitive film 58 that are between substrate 11 and exposed regions 61, 62, 63, and 64 also become exposed during the exposure of photosensitive film 59.

Now referring to FIG. 6, photosensitive films 58 and 59 are developed using a sodium bicarbonate solution having a pH of about 11. The developing step causes the unexposed regions of photosensitive films 58 and 59 to be removed, thereby forming channels 13, 14, and 15. In other words, developing photosensitive layers 58 and 59 results in the formation of a pair of light absorbing strips disposed on the substrate, wherein the pair of light absorbing strips are spaced apart from each other and substantially parallel to each other. The developing step further forms a pair of conductive ribs disposed over the pair of

light absorbing strips, wherein the pair of conductive ribs are spaced apart from each other, substantially parallel to each other, and substantially perpendicular to the pair of light absorbing strips, and wherein the pair of light absorbing strips and the pair of conductive ribs cooperate to form a channel. The resulting structure is then baked in an appropriate atmosphere to decompose the photo-sensitive polymer and bond the glass constituent, thereby forming a cohesive structure that is affixed to substrate 11. By way of example, the resulting structure is baked in air at a temperature of about 520 °C for about 55 minutes. The times, temperatures, and atmosphere in which the resulting structure is baked is not a limitation of the present invention.

Photosensitive films 58 and 59 have been described as negative photosensitive films, however, it should be understood this is not a limitation of the present invention. In other words, photosensitive films 58 and 59 can be positive photosensitive films or a combination of positive and negative photosensitive films.

As those skilled in the art are aware, fiducials are typically formed at the develop step. The fiducials serve as alignment features when aligning two photomasks. Since two photomask steps are performed but there is only a single develop step, mechanical fiducials or alignment features (not shown) are formed on substrate 11. By way of example, the alignment feature or fiducial is a rectangular shaped glass or ceramic material bonded to substrate 11.

Subsequent to the affixation of photosensitive films 58 and 59 to substrate 11, phosphors 23, 24, and 25 are deposited into phosphor channels 13, 14, and 15, respectively, by one of several phosphor deposition methods, which are known to one skilled in the art. An exemplary screen printing process for the deposition of phosphors 23, 24, and 25 includes using a patterned screen to deposit the phosphor material directly into phosphor channels 13, 14, and 15. If a fine pixel pitch is desired, a photo-sensitive polymer binder can be added to the phosphor materials. Then the different color phosphor materials are sequentially silk screened, photo-imaged, and developed. Thereafter, substrate 11 is heated at about 450 °C for about one hour to burn off the photo-sensitive binder.

In accordance with the present embodiment, an aluminum overlayer (not shown) is formed on the phosphor material. Methods for forming the aluminum overlayer are known to those skilled in the art. It should be understood that formation of an aluminum overlayer is optional. Omission of the aluminum overlayer precludes the attenuation of the energy of the incident electrons, which otherwise would occur upon their traversal of the aluminum overlayer.

Referring again to FIG. 2, the electrodes of field emission display 30 include cathode electrode 31 a gate extraction electrode 38, and phosphor channels 61, 62, 63, and 64. Gate extraction electrode 35 is spaced apart from cathode electrode 31 by a dielectric layer 39.

Each electrode is designed to receive a potential from a potential source (not shown).

- 5 During the operation of field emission display 30, potentials are applied to effect electron emission from selected ones of electron emitters 36, in a manner known to one skilled in the art. The emitted electrons traverse interspace region 33 to be received by the opposing phosphors 23, 24, or 25, thereby illuminating the corresponding pixel.

- 10 By now it should be appreciated that a field emission display having an anode plate with phosphor channels and a method of manufacturing the field emission display have been provided. The anode structure is patterned with a thin black surround matrix that is coupled with "ribs" of conductive material running parallel to the long edge of the phosphor sub-pixels, i.e., the phosphor channels. The phosphor channels can be filled with a phosphor material along the entire length of the anode structure, thus negating any sub-pixel printing and the drawbacks associated with this type of printing. For example, pinholes will not be
15 formed in the phosphor material and it will have improved uniformity. Further, the anode structure of the present invention will be more cost efficient to manufacture.

- 20 While specific embodiments of the present invention have been shown and described, further modifications and improvements will occur to those skilled in the art. It is understood that the invention is not limited to the particular forms shown and it is intended for the appended claims to cover all modifications which do not depart from the spirit and scope of this invention. For example, a white paste containing a gas-absorption material may be formed on photosensitive film 59. Further, different types of alignment features may be formed on substrate 11.

CLAIMS

1. A method for manufacturing a field emission display, comprising:
providing a cathode plate having a plurality of electron emitters;
5 providing an anode plate, wherein providing the anode plate comprises:
providing a substrate having a first film disposed thereon, the substrate
having a first edge opposite a second edge and a third edge opposite a fourth edge;
forming a first exposed portion substantially parallel to the first edge;
disposing a second film on the first film;
10 forming a second exposed portion substantially parallel to the third edge;
developing the first and second films, wherein the first and second exposed
portions are fixed to the substrate and portions of the substrate are uncovered; and
disposing phosphor on the uncovered portions of the substrate; and
coupling the anode plate to the cathode plate.

2. The method of claim 1, wherein the substrate is selected from the group of
glass and quartz.

3. The method of claim 1, wherein the first film comprises a photosensitive
20 film.

4. The method of claim 3, wherein the first film comprises a photosensitive
black paste.

5. The method of claim 4, wherein the photosensitive black paste contains up to
25 20% silver by weight.

6. The method of claim 4, wherein the photosensitive black paste comprises an
oxide selected from the group ruthenium oxide and nickel oxide.

7. The method of claim 3, wherein forming a first exposed portion includes
30 exposing the first film to radiation.

8. The method of claim 3, wherein forming the first exposed portion includes forming a plurality of first exposed portions spaced apart from one another and substantially parallel to the first edge.

5 9. The method of claim 1, wherein the second film comprises a photosensitive material.

10. The method of claim 1, wherein the photosensitive material comprises silver.

10 11. The method of claim 1, wherein disposing the phosphor includes screen printing the phosphor onto the uncovered portions of the substrate.

12. The method of claim 1, further including forming an alignment feature on the substrate.

15 13. The method of claim 12, wherein forming the alignment feature comprises coupling a material to the substrate, the material selected from ceramic, glass, plastic, or the like.

20 ~~14.~~ A method for manufacturing a flat panel display, comprising:
providing a substrate having a first photosensitive layer disposed thereon;
exposing a first portion of the first photosensitive layer to radiation;
disposing a second photosensitive layer on the first photosensitive layer;
exposing a first portion of the second photosensitive layer to radiation;
25 developing the exposed first portions of the first and second photosensitive layers to uncover a portion of the substrate; and
disposing a phosphor paste on the uncovered portion of the substrate.

30 15. The method of claim 14, wherein the first photosensitive layer is a photosensitive black paste comprising an oxide selected from the group ruthenium oxide and nickel oxide.

16. The method of claim 14, wherein the second photosensitive layer comprises a photosensitive silver paste.

17. The method of claim 14, wherein exposing the first portion of the photosensitive layer includes exposing at least two rectangular stripes that are substantially parallel to one another and substantially perpendicular to the exposed first portions of the first photosensitive layer.

18. The method of claim 14, wherein developing the exposed first portions of the first and second photosensitive layers includes forming a channel structure in the first and second photosensitive layers.

19. The method of claim 14, further including forming a fiducial on the substrate that allows alignment for exposing the first portion of the second photosensitive layer.

20. The method of claim 14, further including coupling a cathode plate to the substrate.

~~21.~~ An anode for use in a field emission display, comprising:
a substrate having first and second opposing edges;
a pair of light absorbing strips disposed on the substrate, wherein the pair of light absorbing strips are spaced apart from each other and substantially parallel to each other;
a pair of conductive ribs disposed over the pair of light absorbing strips, wherein the pair of conductive ribs are spaced apart from each other, substantially parallel to each other, and substantially perpendicular to the pair of light absorbing strips, and wherein the pair of light absorbing strips and the pair of conductive ribs cooperate to form a channel; and
a phosphor disposed in the at least one channel.

22. The anode of claim 21, further including an alignment feature disposed on the substrate.

23. The anode of claim 21, wherein the pair of conductive ribs comprises up to 20 percent silver by volume.

FIELD EMISSION DISPLAY AND METHOD OF MANUFACTURE

Abstract of the Disclosure

5 A field emission display (30) having an anode plate (10) that has phosphor channels (13, 14, 15). The phosphor channels (13, 14, 15) are formed by depositing a first layer of photosensitive film (58) on a substrate (11). Stripes are patterned into the first layer of photosensitive film (58) using ultraviolet light. A second layer of photosensitive film (59) is formed on the first layer of photosensitive film (58). Stripes are patterned into the second layer of photosensitive film (59) using ultraviolet light. The stripes in the second layer of photosensitive film (58) are substantially perpendicular to the first layer of photosensitive film (59). Both layers of photosensitive film are developed to form channel structures. Phosphor is formed in the channel structures to form the phosphor channels (13, 14, 15). The anode plate (10) is coupled to a cathode plate (31) to form the field emission display (30).

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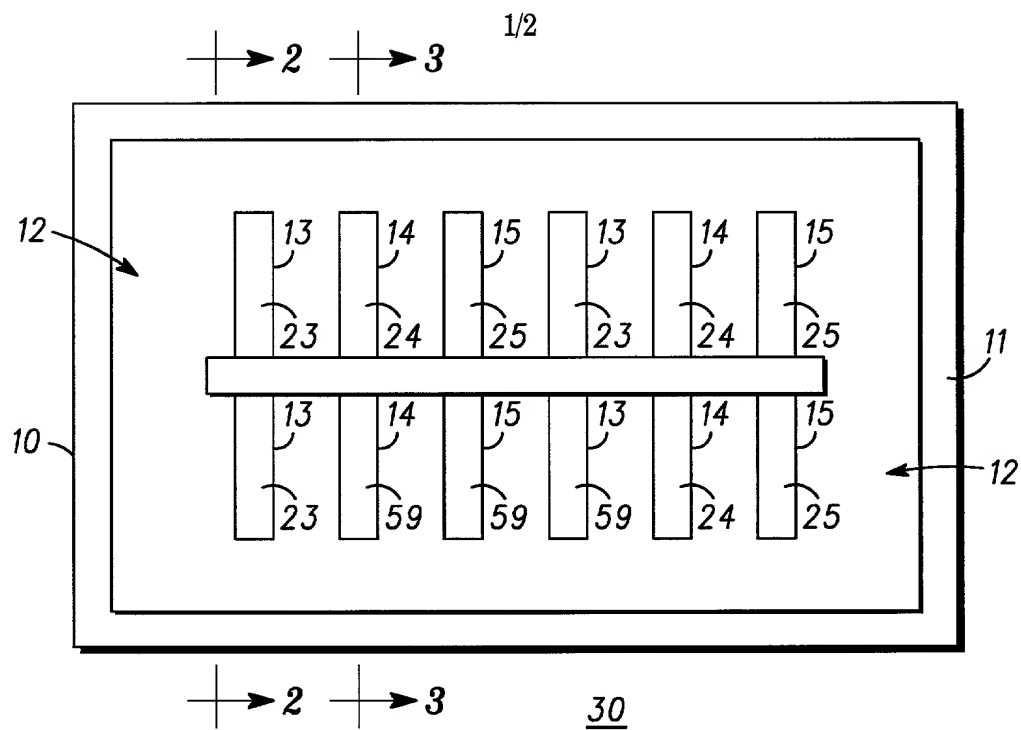


FIG. 1

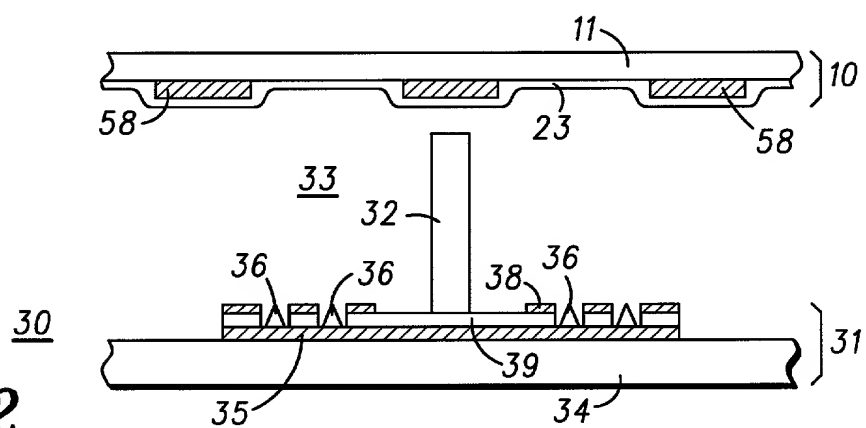


FIG. 2

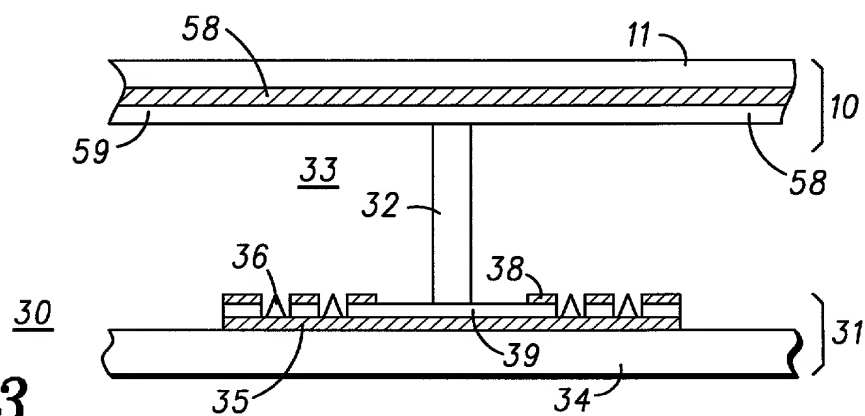


FIG. 3

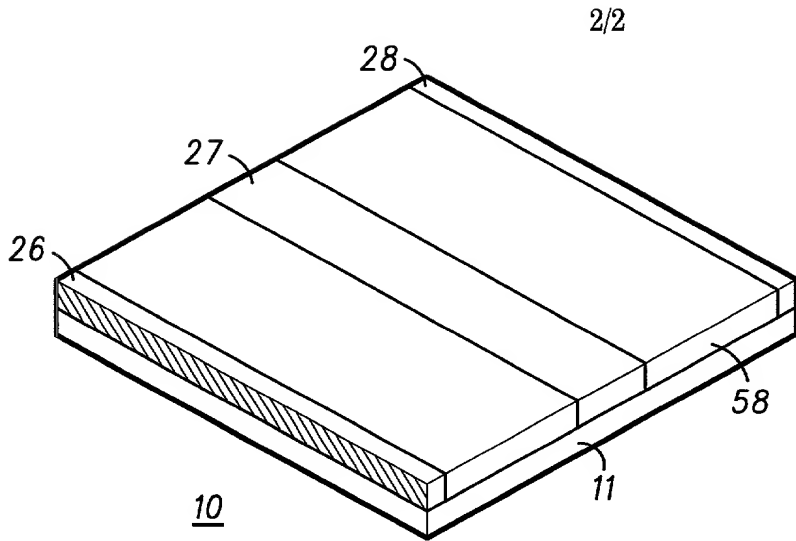


FIG. 4

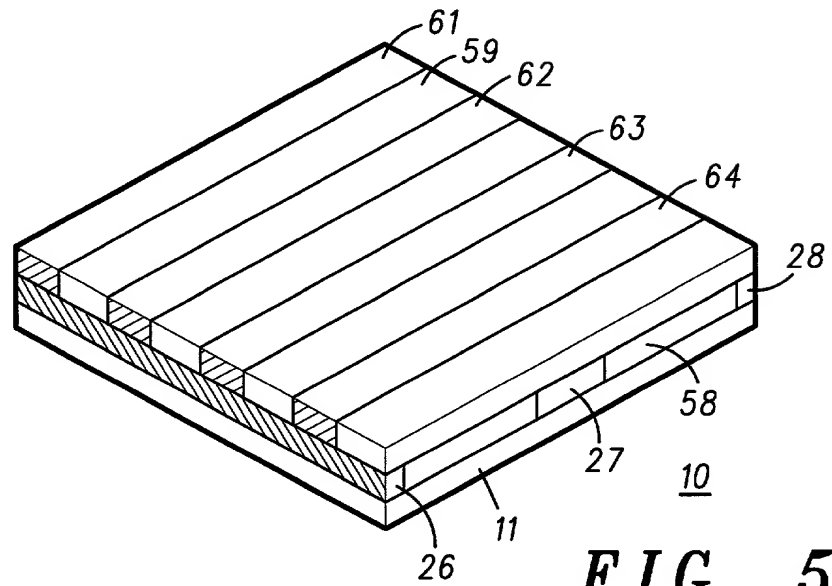


FIG. 5

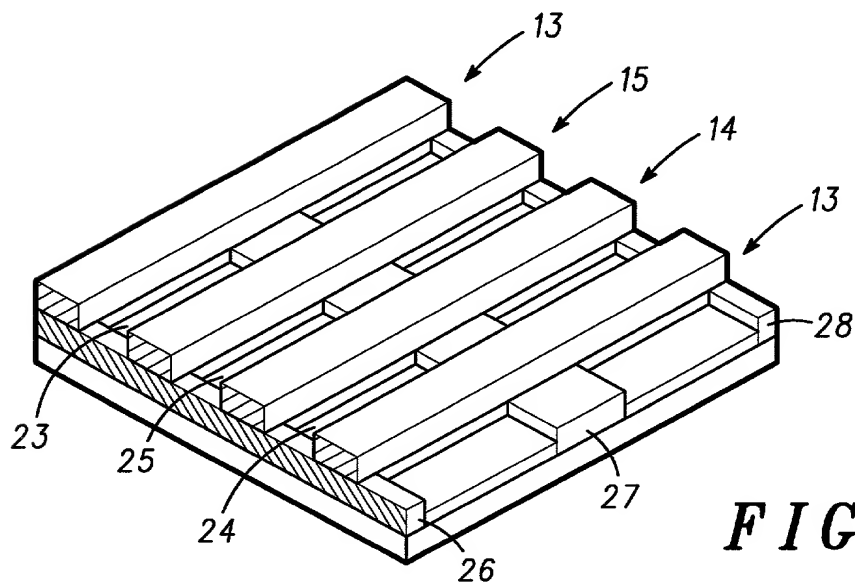


FIG. 6

**COMBINED DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION**

Attorney Docket FD20014

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled FIELD EMISSION DISPLAY AND METHOD OF MANUFACTURE, the specification of which is attached hereto unless the following box is checked:

☐ Application was filed on _____
as Application No. _____
and was amended on _____.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application of which priority is claimed.

Prior Foreign Application(s)		Priority Claimed
		<input type="checkbox"/> Yes <input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)
		<input type="checkbox"/> Yes <input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

(Application Number)	(Filing Date)
(Application Number)	(Filing Date)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below:


(U.S. Parent Application or PCT Parent No.)	(Filing Date)	(Country)
(U.S. Parent Application or PCT Parent No.)	(Filing Date)	(Country)

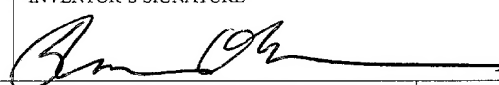
I hereby appoint the attorney(s) and/or agent(s) associated with Customer Number 22863 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

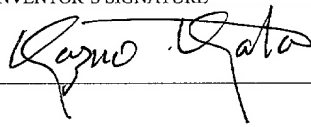
Address all telephone calls to Mr. Kevin D. Wills at telephone no. (480) 441-4302.


Address all correspondence to Customer Number 22863.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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POST OFFICE ADDRESS		
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POST OFFICE ADDRESS				
Same as above				

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POST OFFICE ADDRESS				
Same as above				